Peak EMI Reduction Device for Power Systems

Functional Description

P6P82PS01A is a versatile, 3.3 V Peak EMI reduction device. P6P82PS01A can be interfaced/connected to the PWM frequency controlling node (either RT-CT or RT) to modulate the switching frequency of the PWM controller which in turn reduces the Peak EMI of the power system.

P6P82PS01A has an SSEXTR pin to select different frequency deviations depending upon the value of an external resistor connected between SSEXTR and GND.

MRSEL selects an external or an internal analog Modulation Rate clock. When MRSEL is pulled LOW, different moulation rates can be selected depending upon the value of an external resistor connected between MREXTR and GND. When MRSEL pin is pulled HIGH, an external Modulation clock can be fed through MREXTR pin. Refer *Modulation Rate Selection* table.

P6P82PS01A operates from a 3.3 V \pm 0.3 V supply, and is available in an 8 pin WDFN(2 mm x 2 mm) package.

General Features

- Provides Peak EMI Reduction
- Companion IC for RT-CT or a RT based PWM Controllers
- Supports PWM Switching Frequency up to 5 MHz
- Analog Deviation Selection
- External or Internal Analog ModRate Selection Option
- Supply Voltage: $3.3 \text{ V} \pm 0.3 \text{ V}$
- Dynamic Supply Current less than 5 mA @ 1 MHz
- Operating Temperature Range: 0°C to +70°C
- 8 pin, WDFN(2 mm x 2 mm) Package
- These Devices are Pb-Free and are RoHS Compliant

Application

• P6P82PS01A is targeted for AC-DC, and DC-DC power systems.



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GN = Specific Device Code

M = Date Code

= Pb-Free Device

PIN CONFIGURATION RT-CT/RT 1 8 VDD MREXTR 2 7 MRSEL NC 3 6 NC GND 4 5 SSEXTR

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

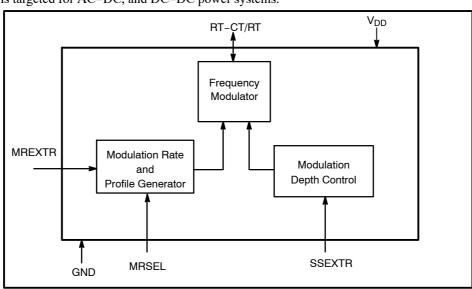


Figure 1. Block Diagram

Table 1. PIN DESCRIPTION

Pin #	Pin Name	Туре	Description	
1	RT-CT/RT	Input/Output	Input/Output pin connected to RT-CT / RT pin of PWM controller	
2	MREXTR	Input	Selects Analog Modulation Rate through external resistor to GND when MRSEL pin pulled LOW. When MRSEL pin pulled HIGH, an external Modulation clock can be fed in to this pin. Has NO default state.	
3	NC	-	Not Connect	
4	GND	Power	Ground	
5	SSEXTR	Input	Analog Deviation Selection through external resistor to GND.	
6	NC	-	Not Connect	
7	MRSEL	Input	Modulation Rate Select. Selects Analog modulation clock when pulled LOW. Selects an External Modulation Clock fed through MREXTR pin, When pulled HIGH. Has an internal pull-down resistor.	
8	VDD	Power	3.3V supply Voltage.	

Table 2. MODULATION RATE SELECTION TABLE

MRSEL	MREXTR	Modulation Rate	
1	External MR Clock	External MR Clock / 96	
0	Connect a Resistor from MREXTR to GND*	Analog	

^{*}Refer to Figure 2. MREXTR vs. MR graph for different Analog Modulation Rate(MR).

Table 3. ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Rating	Unit
V _{DD}	Voltage on any input pin with respect to Ground	-0.5 to +4.6	V
T _{STG}	Storage temperature	-65 to +125	°C
T _s	Max. Soldering Temperature (10 sec)	260	°C
T _J	Junction Temperature	150	°C
T _{DV}	Static Discharge Voltage (As per JEDEC STD22- A114-B)	2	KV

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 4. OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{DD}	Supply Voltage	3	3.6	V
T _A	Operating Temperature	0	70	°C
F _S	PWM Switching Frequency		5	MHz
C _{IN}	Input Capacitance		7	pF

Table 5. DC AND AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{DD}	Supply Voltage		3.0	3.3	3.6	V
V _{IH}	Input HIGH Voltage		0.65*V _{DD}			V
V _{IL}	Input LOW Voltage				0.35*V _{DD}	V
I _{IH}	Input HIGH Current	$V_{IN} = V_{DD}$			50	μΑ
I _{IL}	Input LOW Current	V _{IN} = 0 V			50	μΑ
I _{DD}	Dynamic Supply Current	@1 MHz switching frequency		5		mA
FIN	Switching Frequency				5	MHz

CHARTS

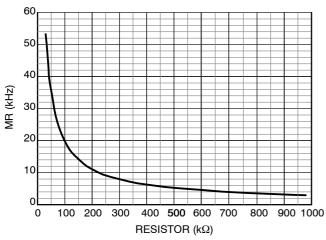


Figure 2. MREXTR vs. MR

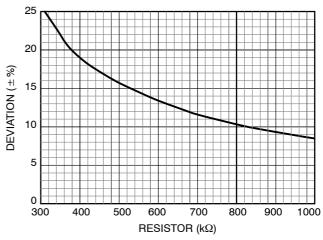


Figure 3. Deviation vs. SSEXTR (@ Switching Frequency = 280 kHz, MR = 25 kHz)

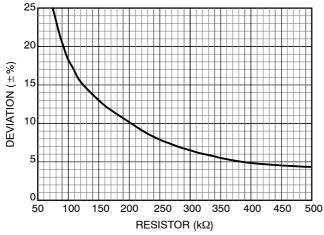


Figure 4. Deviation vs. SSEXTR (@ Switching Frequency = 1 MHz, MR = 25 kHz)

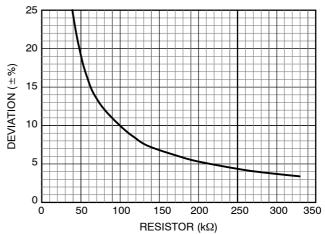


Figure 5. Deviation vs. SSEXTR (@ Switching Frequency = 1.6 MHz, MR = 25 kHz)

NOTE: Device-to-Device variation of Deviation is \pm 10%

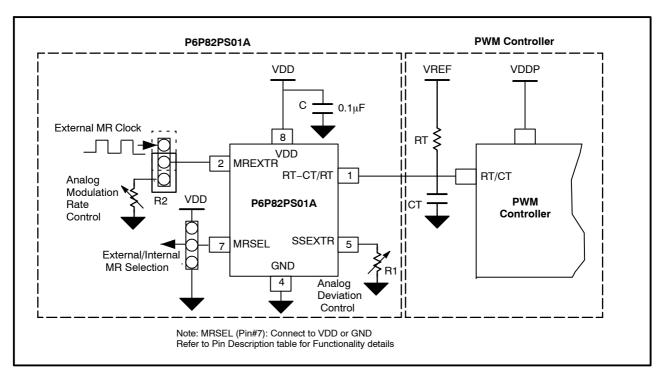


Figure 6. Typical Application Schematic

ORDERING INFORMATION

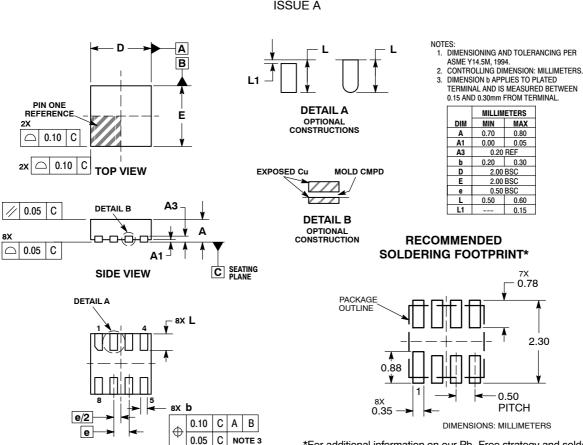
Ordering Code	Marking	Temperature	Package Type	Shipping [†]
P6P82PS01AG-08CR	GN	0°C to +70°C	8-pin (2 mm x 2 mm) WDFN (Pb-Free)	Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}A "microdot" placed at the end of last row of marking or just below the last row toward the center of package indicates Pb-Free.

PACKAGE DIMENSIONS

WDFN8 2x2, 0.5P CASE 511AQ-01 **ISSUE A**



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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